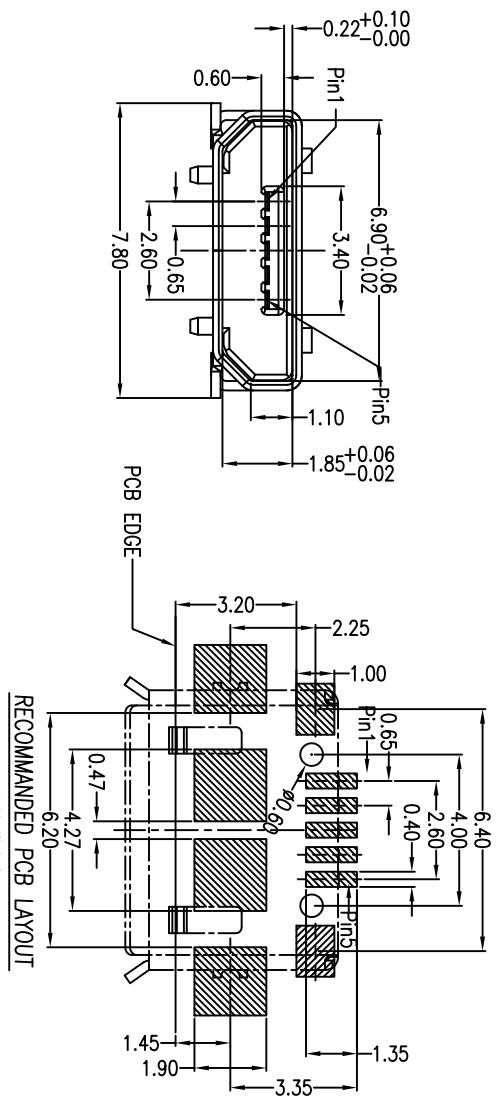
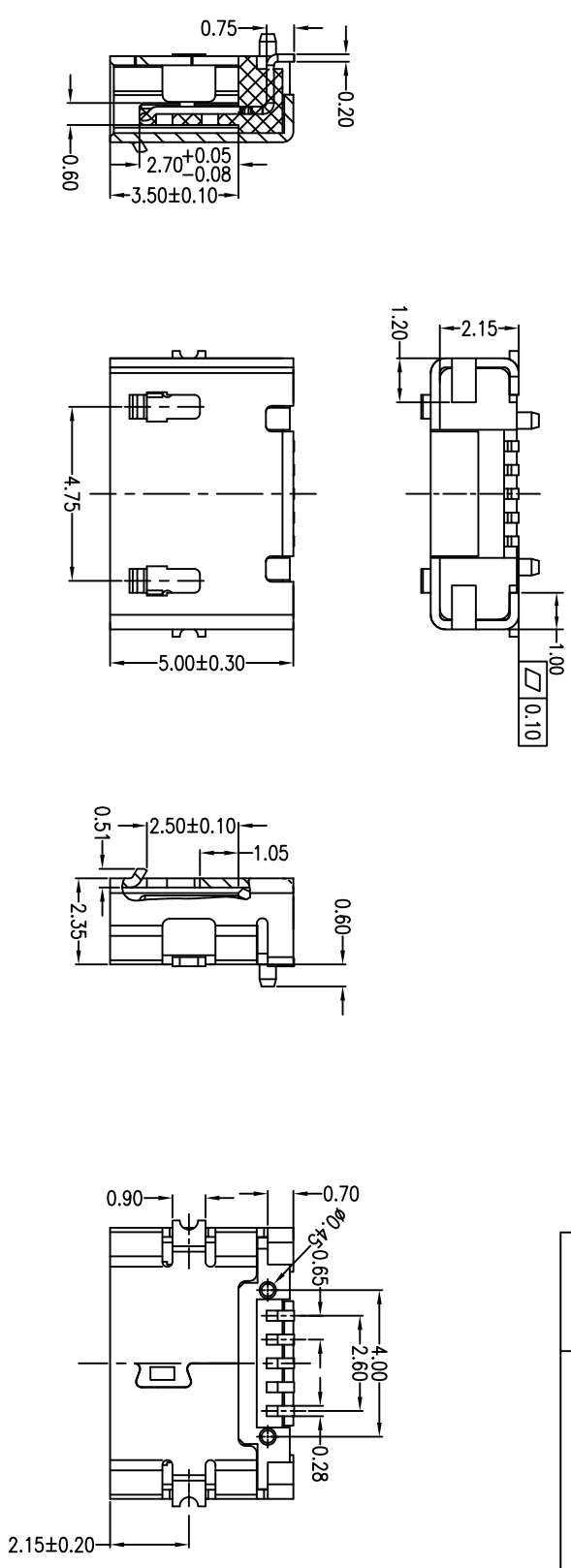


MAPX	MODIFICATION	DATE
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- Note:
- 1.Material:
- Housing: High temperature thermoplastic with g.f.Ul94V-0
 - Contact: copper alloy,t=0.20mm
 - Shell: copper or sus304,t=0.25mm
- 2.Specification:
- Current rating:1.5PIN 1.8A Max/2.3,4PIN 1A Max.
 - Dielectric withstanding voltage: 100 V(ac) for 1 min.
 - Contact resistance: 30 mΩ Max.
 - Insulation resistance: 100 MΩ Min.
 - Total mating force: 3.57 Kgf Max.
 - Total unmating force: 1.0 Kgf Min
 - Temperature range: -30C~80C

PCB图仅供参考

深圳市精拓金电子有限公司

产品图
PRODUCT CHART DWG

公差一览表
TOLERANCE UNLESS OTHERWISE

X	±0.25	X	±5.°
X	±0.20	X	±2.°
XX	±0.15	XX	±1.°
XXX	±0.10	XXX	±0.5°

单位	MM	制图	GAVIN	制图料号	
比例	1:1	审核		产品名称	MICRO USB B/F SMT 有柱
日期	2012.06.10	核准		产品编号	
DATE		APPD		角法	
				版本	AD